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Tab settings ⇔ ⇔ ⇔ To the Honorable C			
	commissioner of Patents and Tradema	arks: Please record the attached original documents or copy thereof.	
Name of conveying party(ies) 1) ROHM CO., LTD. 2) MITSUBISHI DENKI KABUSHIKI KAISHA 3) HITACHI, LTD. Additional name(s) of conveying party(ies) attached? [] Yes [X] No 3. Nature of conveyance: [X] Assignment		1. Name and address of receiving party(ies) Name: ROHM CO. LTD. Address: 21, Saiin Mizosaki-cho, Ukyo-ku Kyoto-shi, Kyoto 615-8585, JAPAN Additional name(s) & address(es) attached? [] Yes [X] No.	
Execution Date: 1) A 2) August 22, 2005	August 9, 2005 3) August 3, 2005		
2) August 11, 1000	oj riagasto, noto		
	No.(s)	pplication, the execution date of the application is: B. Patent No.(s)	
10/840,677 005 FFANAEIA 00000062 108	40677		
10/840,677 005 FFANAEIA 00000062 108 021	40677	B. Patent No.(s) sattached? [] Yes [X] No	
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10/840,677 005 FFANAEIA 00000062 108 021 5. Name and address of concerning documents Steven M. Rabin RABIN & BERDO,	A0677 Additional numbers of party to whom correspondences should be mailed:	B. Patent No.(s) sattached? [] Yes [X] No e 6. Total number of applications and patents involved: [
10/840,677 005 FFANAEIA 00000062 108 021 5. Name and address of concerning documents Steven M. Rabin	Additional numbers of party to whom correspondences should be mailed:	B. Patent No.(s) sattached? [] Yes [X] No 6. Total number of applications and patents involved: [7. Total fee (37 CFR 3.41)	
10/840,677 005 FFANAEIA 00000062 108 021 5. Name and address of concerning document of the concerning	Additional numbers of party to whom correspondences should be mailed: P.C.	B. Patent No.(s) sattached? [] Yes [X] No 6. Total number of applications and patents involved: [7. Total fee (37 CFR 3.41)	
10/840,677 005 FFANAEIA 00000062 108 021 5. Name and address of concerning document steven M. Rabin RABIN & BERDO, 1101 14th Street Suite 500	A0677 Additional numbers of party to whom correspondences should be mailed: P.C. 0005	B. Patent No.(s) sattached? [] Yes [X] No 6. Total number of applications and patents involved: [7. Total fee (37 CFR 3.41)	
10/840,677 005 FFANAEIA 00000062 108 021 5. Name and address of concerning document of the street o	Additional numbers of party to whom correspondences should be mailed: P.C. 1-8976 8-0924 ature.	B. Patent No.(s) stattached? [] Yes [X] No e 6. Total number of applications and patents involved: [7. Total fee (37 CFR 3.41)\$40.00 [X] Enclosed	

Signature

Printed Name of Person Signing

Date

ASSIGNMENT OF APPLICATION FOR UNITED STATES LETTERS PATENT

WHEREAS ROHM CO., LTD. of 21, Saiin M	Mizosaki-cho, Ukyo-ku, Kyoto-shi, Kyoto 615-8585,
JAPAN, MITSUBISHI DENKI KABUSHIKI KAISHA of 2	-3, Marunouchi 2-chome, Chiyoda-ku, Tokyo 100-
8310, JAPAN, and HITACHI, LTD. of 6-6, Marunouchi	1-chome, Chiyoda-ku, Tokyo 100-8280, JAPAN,
hereinafter referred to collectively as the assignor, owns the p	
relating to SEMICONDUCTOR CHIP PRODU	CTION METHOD, SEMICONDUCTOR DEVICE
PRODUCTION METHOD, SEMICONDUCTOR CHIP, A	ND SEMICONDUCTOR DEVICE
instrument; said application to be filed in the	
AND WHEREAS ROHM CO. LTD. of 21, Saiin M	<u>izosaki-cho, Ukyo-ku, Kyoto-shi, Kyoto 615-8585, JAPAN</u>
and Renesas Technology Corporation of 4-1, Marunouchi 2	-chome, Chiyoda-ku, Tokyo 100-6334, JAPAN, hereinafter
referred to as the assignee, is desirous of acquiring the	entire right, title, and interest in and to said application,
including any and all divisions and continuations thereof, and	in and to said invention and any and all patents which may
be granted therefor, including any and all renewals, reissues,	and prolongations thereof;
assigns, any and all acts relating to the obtaining or to the ass reissues, and prolongations thereof. AND said assignor authorizes and requests the Commis on said application, and on any and all divisions and continua successors and assigns, in accordance herewith.	cluding any and all divisions and continuations thereof, and granted therefor, including any and all renewals, reissues, e's successors and assigns, to have, hold, exercise, and continuations thereof, and said invention and any and all renewals, reissues, and prolongations thereof, with all the grown or appertaining thereto, for and during the term of y and all renewals, reissues, and prolongations thereof, for cessors and assigns, in as ample and beneficial a manner me, if this assignment had not been made, equest of said assignee, or said assignee's successors of certing of said patents, including any and all renewals, sioner of Patents and Trademarks to issue Letters Patentions thereof, to said assignee, and said assignee's
EXECUTED, this day of	
ASSIGNOR: ROHM CO., LTD.	WITNESSES:
Signature: Dept 2	Signature:
Name: Takaaki Nagura	Name:
Title: Group Manager	Address:
	Signature:
	Name:

Page 1 of 2

ASSIGNMENT OF APPLICATION FOR UNITED STATES LETTERS PATENT -Page 2 of 2-

EXECUTED, this day of	, 2005.
SSIGNOR: MITSUBISHI DENKI KABUSHIKI KAIS	SHA WITNESSES:
signature:	Signature:
lame:Fumio Okusa	Name:
itle: Executive Vice President	Address:
	Signature:
	Name:
	Address:
EXECUTED, this day of	, 2005.
ASSIGNOR: <u>HITACHI, LTD.</u>	WITNESSES:
Signature:	Signature:
Yasuo Sakuta	Name:
itle: Executive Officer, Intellectual	Address:
Property Group	
	Signature:
	Name:
	Address:

RABIN & BERDO, P.C., Washington, D.C.

PATENT REEL: 017220 FRAME: 0899

Attorney Reference	Al 343
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ASSIGNMENT OF APPLICATION FOR	UNITED STATES LETTERS PATENT
WHEREAS ROHM CO., LTD. of 21, Saiin M	<u> Mizosaki-cho, Ukyo-ku, Kyoto-shi, Kyoto 615-8585,</u>
JAPAN, MITSUBISHI DENKI KABUSHIKI KAISHA of 2	-3, Marunouchi 2-chome, Chiyoda-ku, Tokyo 100-
8310, JAPAN, and HITACHI, LTD. of 6-6, Marunouchi	1-chome, Chiyoda-ku, Tokyo 100-8280, JAPAN,
nereinafter referred to collectively as the assignor, owns the p	patent rights to a certain improvement
relating to SEMICONDUCTOR CHIP PRODU	ICTION METHOD, SEMICONDUCTOR DEVICE
PRODUCTION METHOD, SEMICONDUCTOR CHIP, A	ND SEMICONDUCTOR DEVICE .
instrument; said application to be filed in the [x] a patent application having been filed in the	
Serial No, the United State	
	lizosaki-cho, Ukyo-ku, Kyoto-shi, Kyoto 615-8585, JAPAN
and Renesas Technology Corporation of 4-1, Marunouchi 2	
referred to as the assignee, is desirous of acquiring the	-
ncluding any and all divisions and continuations thereof, and	
be granted therefor, including any and all renewals, reissues,	and prolongations thereot; on of One Dollar (\$1.00), and other good and valuable
assigns, any and all acts relating to the obtaining or to the ass reissues, and prolongations thereof. AND said assignor authorizes and requests the Commis on said application, and on any and all divisions and continua successors and assigns, in accordance herewith.	cluding any and all divisions and continuations thereof, and granted therefor, including any and all renewals, reissues se's successors and assigns, to have, hold, exercise, and continuations thereof, and said invention and any and all renewals, reissues, and prolongations thereof, with all the g from or appertaining thereto, for and during the term of any and all renewals, reissues, and prolongations thereof, for cessors and assigns, in as ample and beneficial a manner ame, if this assignment had not been made. The request of said assignee, or said assignee's successors of serting of said patents, including any and all renewals, assigner of Patents and Trademarks to issue Letters Patentaions thereof, to said assignee, and said assignee's
EXECUTED, this day of	, 2005.
ASSIGNOR: ROHM CO., LTD .	WITNESSES:
Signature:	Signature:
Name: Takaaki Nagura	Name:
Title: Group Manager	Address:
	Signature:
	Name:

Page 1 of 2

ASSIGNMENT OF APPLICATION FOR UNITED STATES LETTERS PATENT -Page 2 of 2-

	EXECUTED, this Aday of	ug.	_, 2005.
ASSIGNOR: M	ITSUBISHI DENKI KABUSHIKI KAISHA	WITNESSES:	
Signature:		Signature:	
Name: Fun	nio Okusa	Name:	
Title: Exe	ecutive Vice President	Address:	
		Signature:	
		Name:	
		Address:	
	EXECUTED, this 3 day of	lugust	_, 2005.
ASSIGNOR: H	ITACHI, LTD.	WITNESSES:	
Signature:	Yas Aukutu	Signature:	
Name:Y	asuo Sakuta	Name:	
Title: Execut	tive Officer, Intellectual	Address:	
Property G	roup		
		Signature:	
		Name:	<u> </u>
		Address:	

RABIN & BERDO, P.C., Washington, D.C.

RECORDED: 11/14/2005

PATENT REEL: 017220 FRAME: 0901